

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-30V	29mΩ@-10V	-6.5A
	46mΩ@-4.5V	

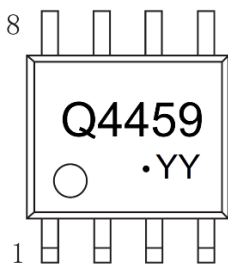
### Feature

- TrenchFET Power MOSFET
- Excellent  $R_{DS(on)}$
- Low Gate Charge

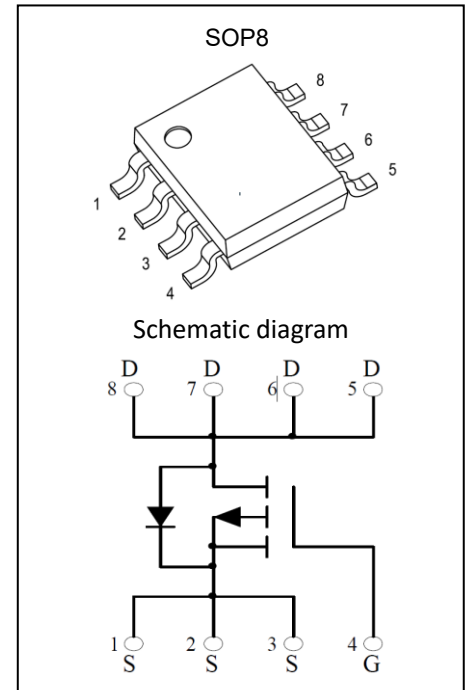
### Application

- Load Switch for Portable Devices
- Battery Switch

### MARKING:



Q4459 = Device code  
 YY = Date Code  
 Solid dot = Pin1 indicator  
 Solid dot = Green molding compound device



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	-6.5	A
Pulsed Drain Current	$I_{DM}$	-26	A
Power Dissipation	$P_D$	1.4	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	89	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

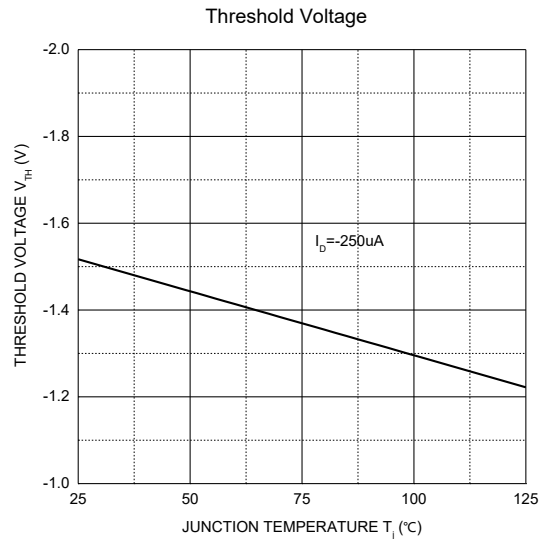
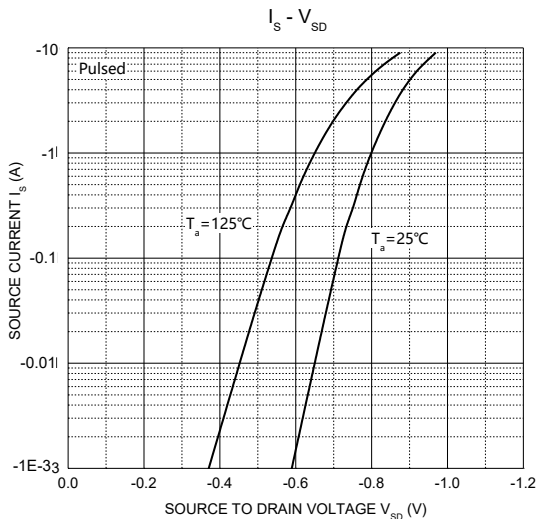
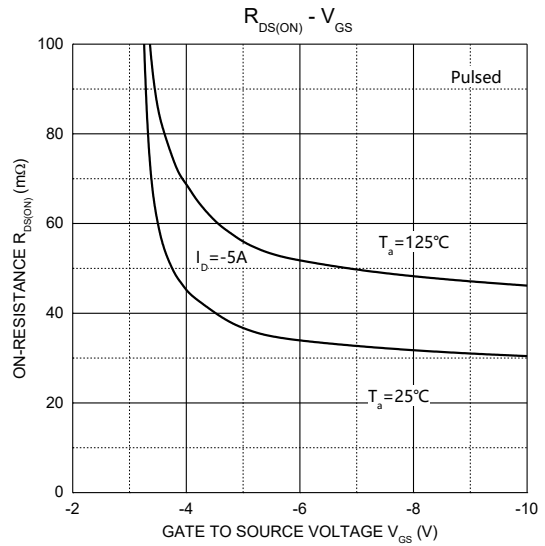
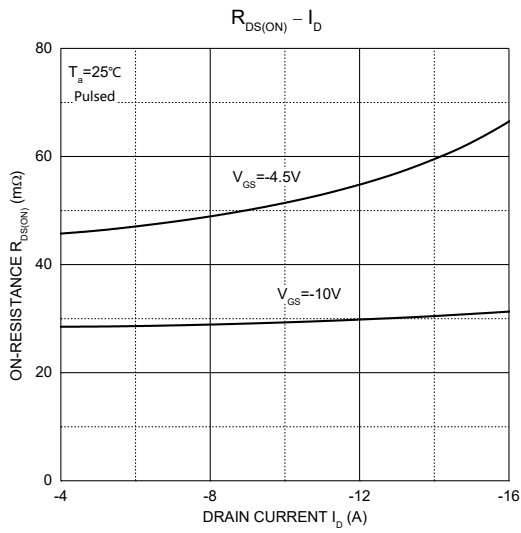
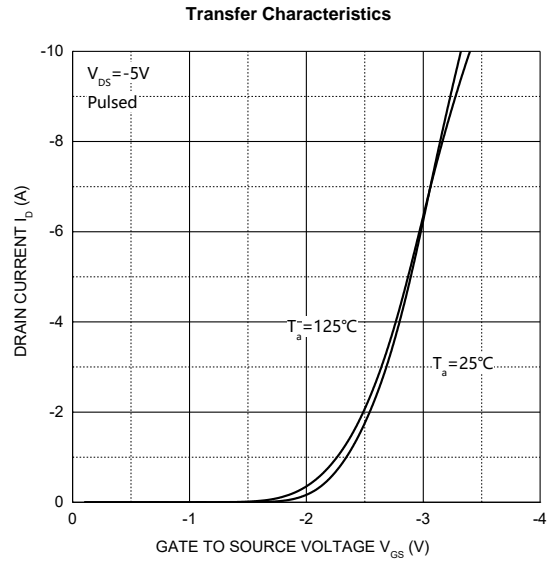
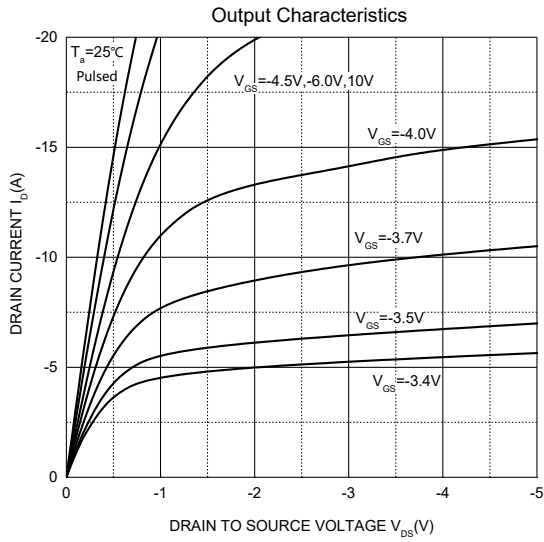
**MOSFET ELECTRICAL CHARACTERISTICS (T<sub>j</sub>=25°C unless otherwise noted)**

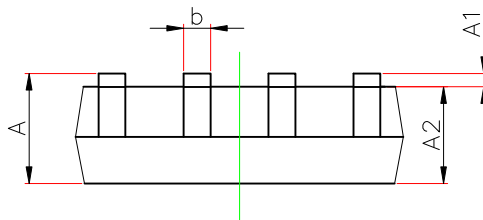
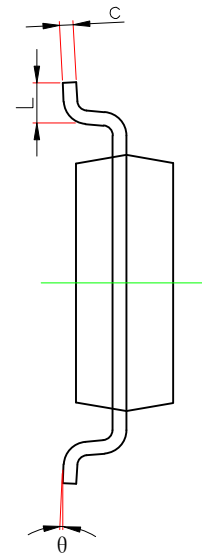
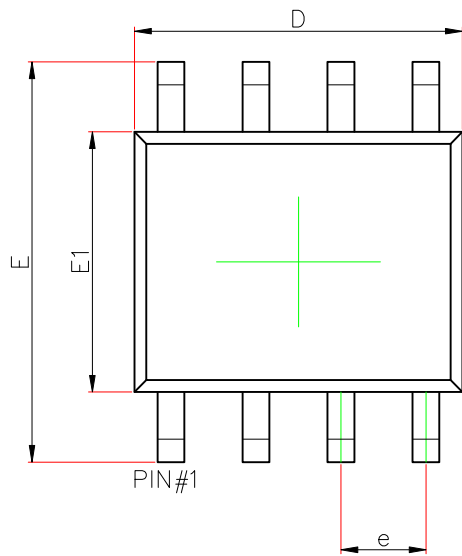
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V			-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±0.1	μA
<b>On Characteristics<sup>(1)</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.4	-2.5	V
Drain-Source on-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A		29	46	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A		46	72	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -6.5A	6			S
<b>Dynamic Characteristics<sup>(2)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, f = 1MHz		850		pF
Output Capacitance	C <sub>oss</sub>			100		
Reverse Transfer Capacitance	C <sub>rss</sub>			65		
<b>Switching Characteristics<sup>(2)</sup></b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -6.5A		14		nC
Gate-Source Charge	Q <sub>gs</sub>			2.5		
Gate-Drain Charge	Q <sub>gd</sub>			4		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15V, I <sub>D</sub> = -6A, V <sub>GS</sub> = -10V, R <sub>G</sub> = 3Ω		9.8		ns
Turn-On Rise Time	t <sub>r</sub>			7.2		
Turn-Off Delay Time	t <sub>d(off)</sub>			24		
Turn-Off Fall Time	t <sub>f</sub>			9		
Gate Resistance	R <sub>g</sub>	f = 1MHz			50	Ω
<b>Drain-Source Diode Characteristics</b>						
Drain-Source Diode Forward Voltage <sup>(1)</sup>	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A		-0.78	-1.2	V
Continuous Drain-Source Forward Current	I <sub>S</sub>				-6.5	A
Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>				-26	

**Notes:**

1. Pulse test; pulse width ≤ 300μs, duty cycle ≤ 2%.
2. Guaranteed by design, not subject to production testing.

**Typical Electrical and Thermal Characteristics**



**SOP8 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.156	0.250	0.006	0.010
D	4.700	5.100	0.185	0.201
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.700	4.100	0.146	0.161
L	0.400	1.270	0.016	0.05
$\theta$	0°	8°	0°	8°

**Attention:**

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.